



AGH UNIVERSITY OF SCIENCE AND TECHNOLOGY

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Faculty of Computer Science, Electronics and Telecommunications

DEPARTMENT OF ELECTRONICS

ELECTRONIC DEVICES

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p-n JUNCTION JUNCTION DIODE



Semiconductors, and what's next ?

- What do we need semiconductors for?
- Why do we need two types of semiconducting materials?
- What can we make of them?

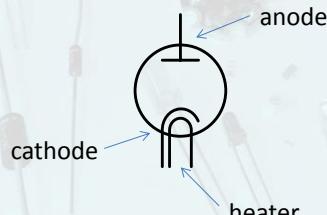
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TUBE DIODE



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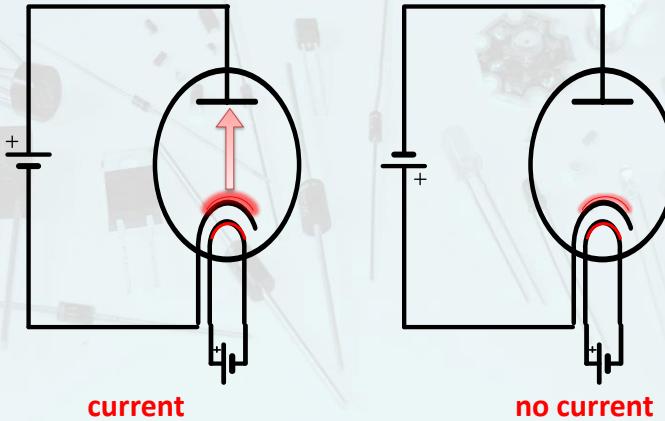
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TUBE DIODE - how does it works ?



DIODE – one-way valve



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TUBE DIODE vs. SEMICONDUCTOR DIODE



Tube diode – mostly drawbacks:

large,
glass,
heater,
high voltage,
difficult to miniaturize

Semiconductor diode – benefits:

small,
large range of voltages and currents,
it can be integrated and miniaturized
resistant to shocks

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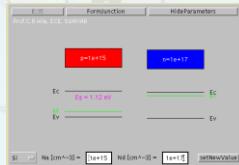
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A few questions:

- What will we need to make a tiny diode?
- What kind of semiconductors?
- What is a p-n junction?
- **What are design steps?**

The answer:



<http://www.acsu.buffalo.edu/~wie/applet/pnformation/pnformation.html>

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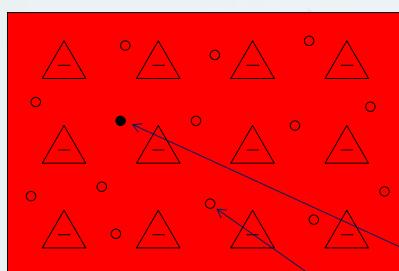
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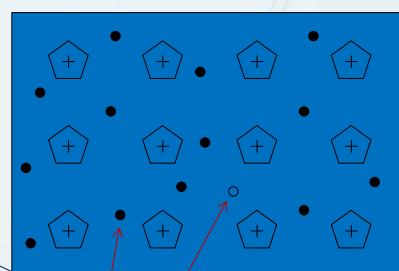


p-n JUNCTION- „components”

P



N



- ▲ an ion of an acceptor dopant,
- ◆ an ion of a donor dopant,
- an electron,
- a hole

minority carrier

majority carrier

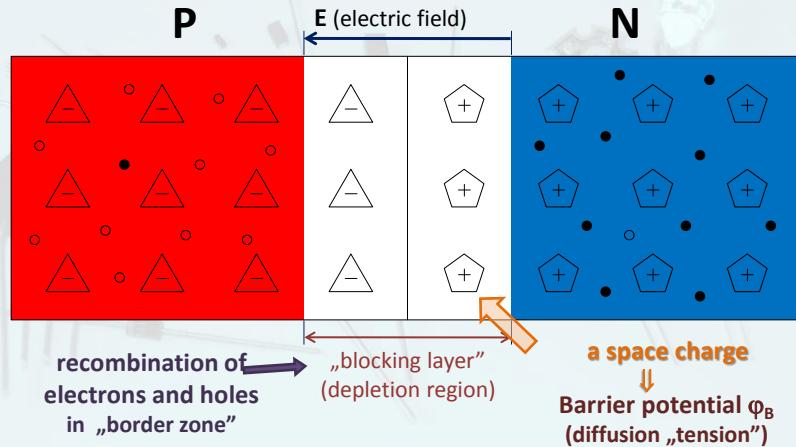
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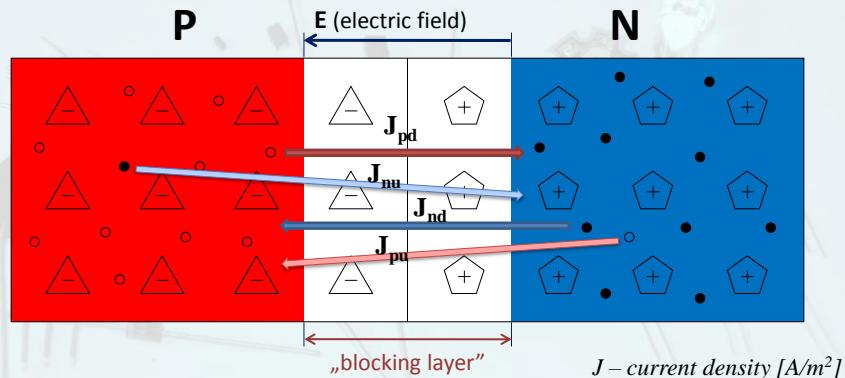
p-n JUNCTION- „merging the components”

An experiment: „merging” p and n semiconductors



p-n JUNCTION

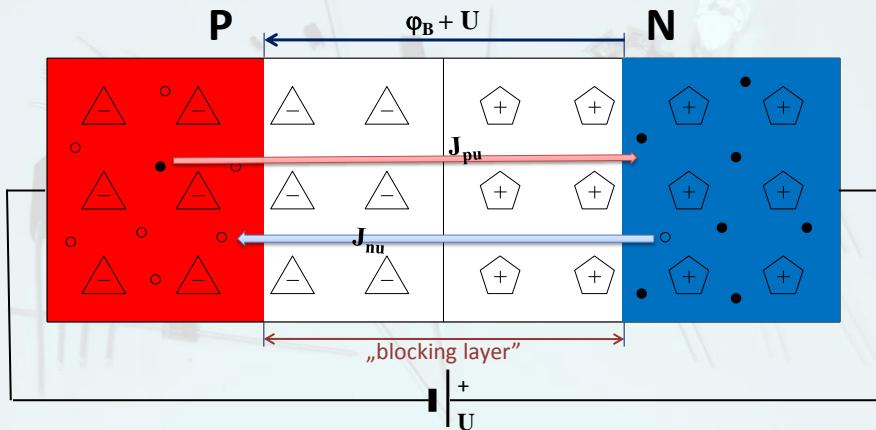
THERMODYNAMIC EQUILIBRIUM



$$J_{pd} - J_{pu} = 0, J_{nd} - J_{nu} = 0$$

p-n JUNCTION

REVERSE BIAS POLARIZATION



ZŁĄCZE p-n

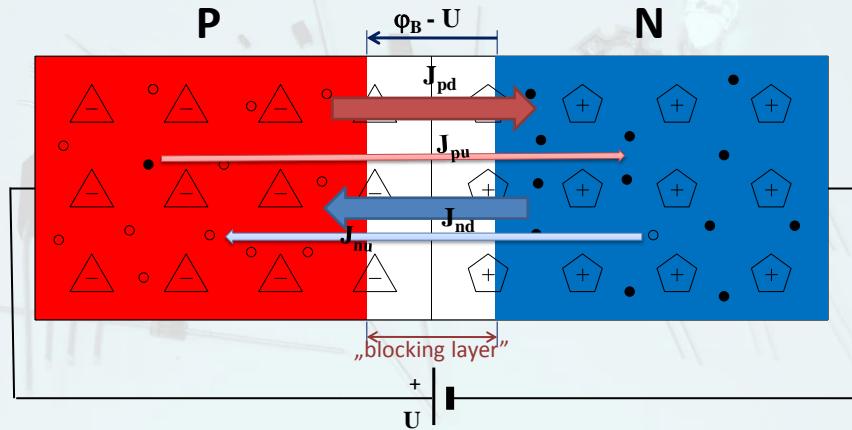
REVERSE BIAS POLARIZATION

Increased potential barrier ($\psi_B + U$) results in complete **disappearance** of the majority carriers diffusion currents.

There exist only **drift** currents of minority carriers that are independent of the voltage.

p-n JUNCTION

FORWARD BIAS POLARIZATION



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ZŁĄCZE p-n

FORWARD BIAS POLARIZATION

Reduced potential barrier ($\psi_B - U$) causes **large** diffusion currents flow of majority carriers and **low** drift current of minority carriers.

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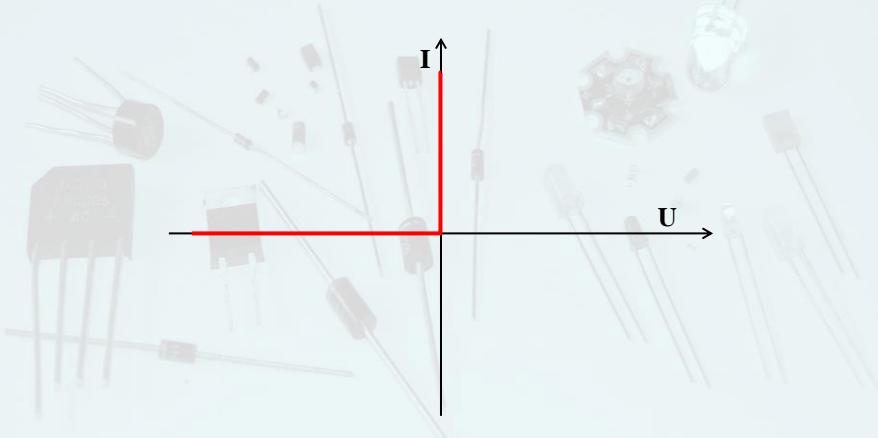
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I vs. U characteristic of the junction

IDEAL DIODE - electronic valve



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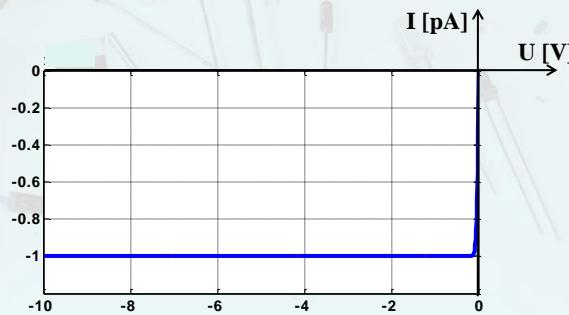


I vs. U characteristic of the junction

first approach

For the reverse bias polarization, there is a constant current associated with drift of minority carriers (J_u).

Its value is independent of the value of the biasing voltage.



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I vs. U characteristic of the junction

first approach

For forward bias polarization

according to the Maxwell-Boltzmann statistics, probability of particles transition over the energy barrier W is: $f(W) = \exp(-W/kT)$

energy barrier for the diffusing majority carriers : $W = q(\varphi_B - U)$

Therefore,

$$J_d = ae \frac{-q(\varphi_B - U)}{kT} \quad \begin{array}{l} \text{- diffusion current density (proportional to the} \\ \text{number of carriers with energies greater than } W \end{array}$$

a – proportionality factor

$$\text{for } U=0 \quad J_d = J_u$$

$$J_d = J_u = ae \frac{-q\varphi_B}{kT} \Rightarrow a = J_u e^{\frac{q\varphi_B}{kT}}$$



I vs. U characteristic of the junction

first approach

For forward bias polarization cont.

$$\text{After substituting: } J_d = J_u e^{\frac{q\varphi_B}{kT}} e^{\frac{-q(\varphi_B - U)}{kT}} = J_u e^{\frac{q\varphi_B - q\varphi_B + qU}{kT}}$$

$$\text{and finally: } J_d = J_u e^{\frac{qU}{kT}} = J_u e^{\frac{U}{\varphi_T}} \quad \varphi_T = \frac{kT}{q} \begin{array}{l} \text{electrothermal} \\ \text{potential} \\ \text{(denoted as } U_T) \end{array}$$

$$\text{knowing that: } J = J_d - J_u \text{ we obtain: } J = J_u e^{\frac{U}{\varphi_T}} - J_u$$

After all:

$$J = J_u \left(e^{\frac{U}{\varphi_T}} - 1 \right)$$

Shockley's equation



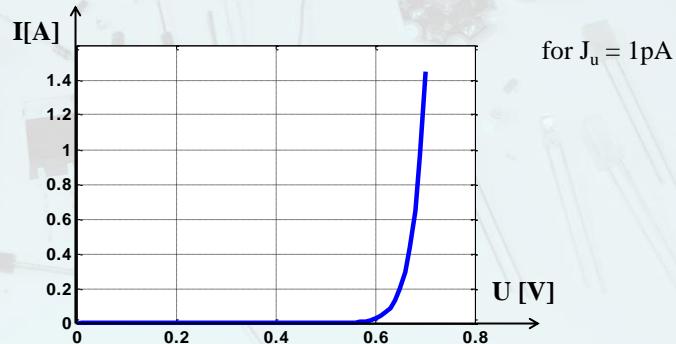
William Shockley
1900-1989
<http://www.magnet.fsu.edu/education/tutorials/pioneers/shockley.html>



I vs. U characteristic of the junction

first approach

$$J = J_u \left(e^{\frac{U}{\varphi_T}} - 1 \right)$$



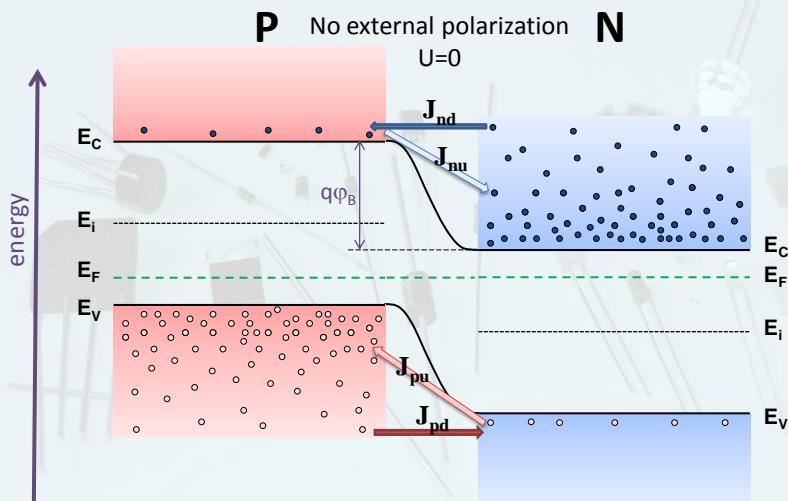
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ENERGY BAND MODEL OF PN JUNCTION



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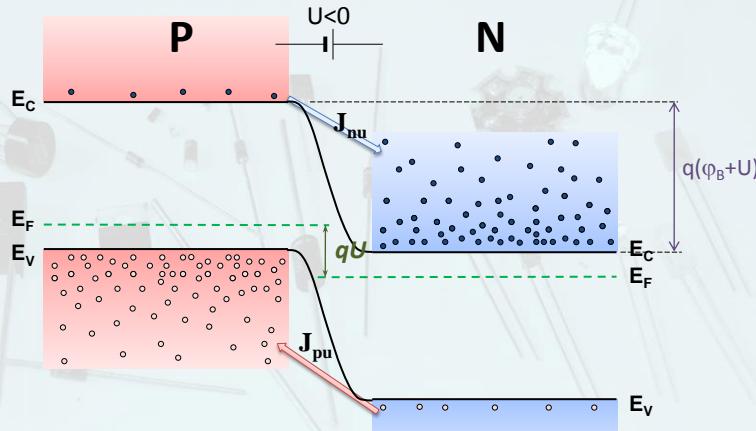
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ENERGY BAND MODEL OF PN JUNCTION



REVERSE BIAS POLARIZATION



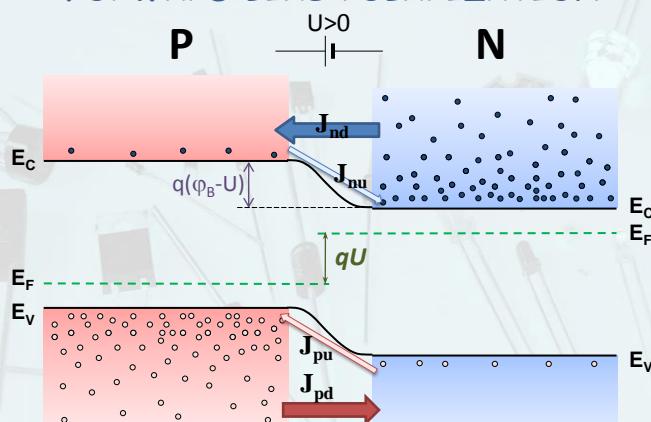
Increased potential barrier ($\varphi_B + U$) results in a complete disappearance of the majority carriers diffusion currents. There only remain drift currents of minority carriers, independent of the voltage.



ENERGY BAND MODEL OF PN JUNCTION



FORWARD BIAS POLARIZATION

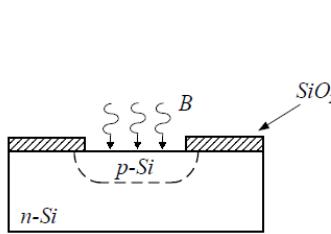


Decreased potential barrier ($\varphi_B - U$) causes large diffusion currents flow of majority carriers and small drift currents of minority carriers

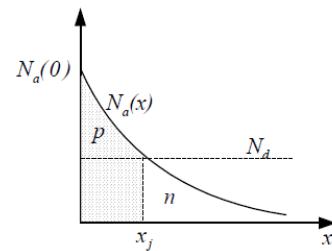


HOW IS PN JUNCTION CREATED?

- Diffusion junction – diffusion of donor or acceptor atoms



Diffusion of boron atoms through a window in silicon oxide



The distribution of the acceptor dopant concentration for diffusion from a source with an unlimited capacity

$$\text{LINEAR JUNCTION} \quad N(x) = N_a - N_d \approx -ax$$

Figures from: S. Kuta „Elementy i układy elektroniczne”, AGH 2000

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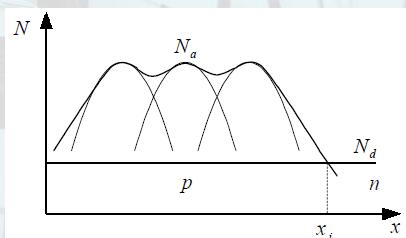
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HOW IS PN JUNCTION CREATED?

- Implant junction – „bombardment” of Si crystal by dopant ions with very high energy (hundreds of keV)



The distribution of the acceptor dopant introduced into the semiconductor by multiple implantation

ABRUPT JUNCTION

Figure from: S. Kuta „Elementy i układy elektroniczne”, AGH 2000

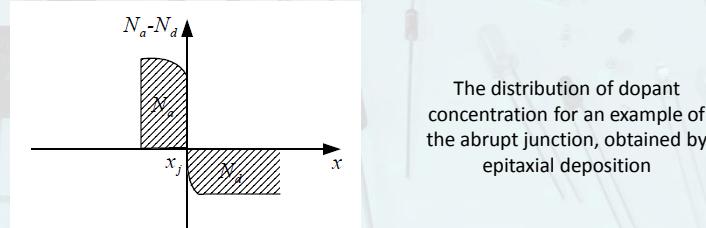
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HOW IS PN JUNCTION CREATED?

- Epitaxial junction – semiconductor epitaxial layer deposition from the atmosphere enriched with elements of dopants



The distribution of dopant concentration for an example of the abrupt junction, obtained by epitaxial deposition

ABRUPT JUNCTION

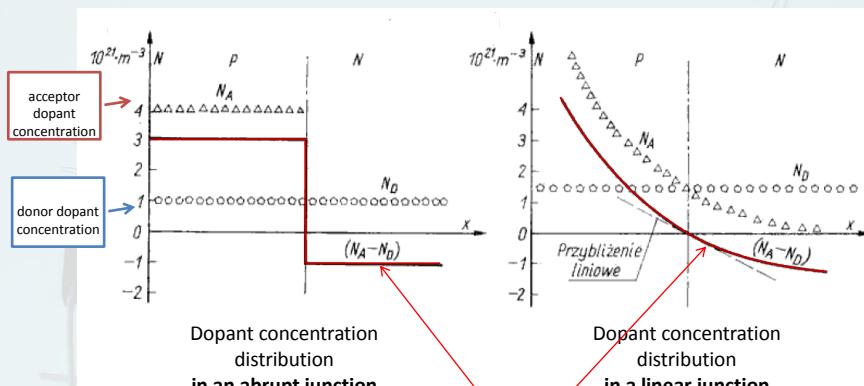
Figures from: S. Kuta „Elementy i układy elektroniczne”, AGH 2000

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ABRUPT AND LINEAR JUNCTION



Effective distribution of dopant concentration determining the type of a semiconductor

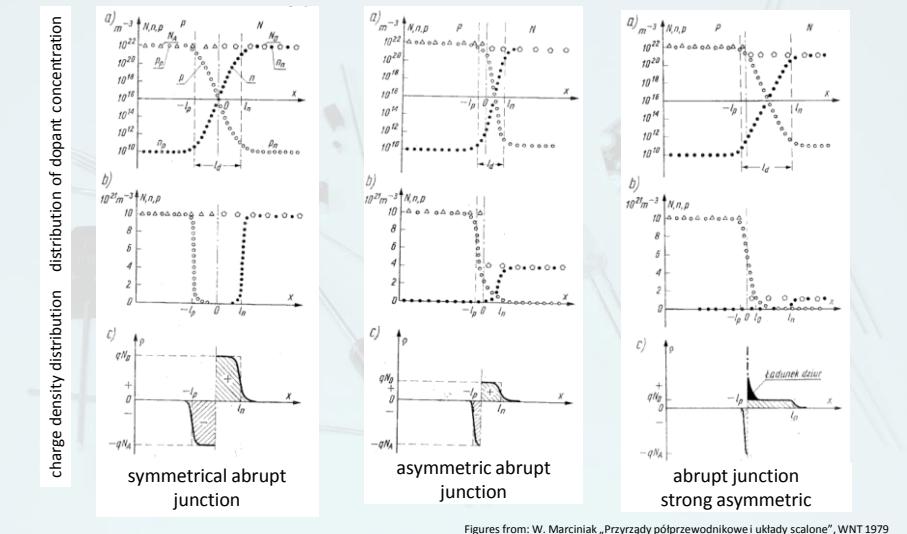
Figures from: W. Marciniaik „Przyrządy półprzewodnikowe i układy scalone”, WNT 1979

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ABRUPT PN JUNCTION



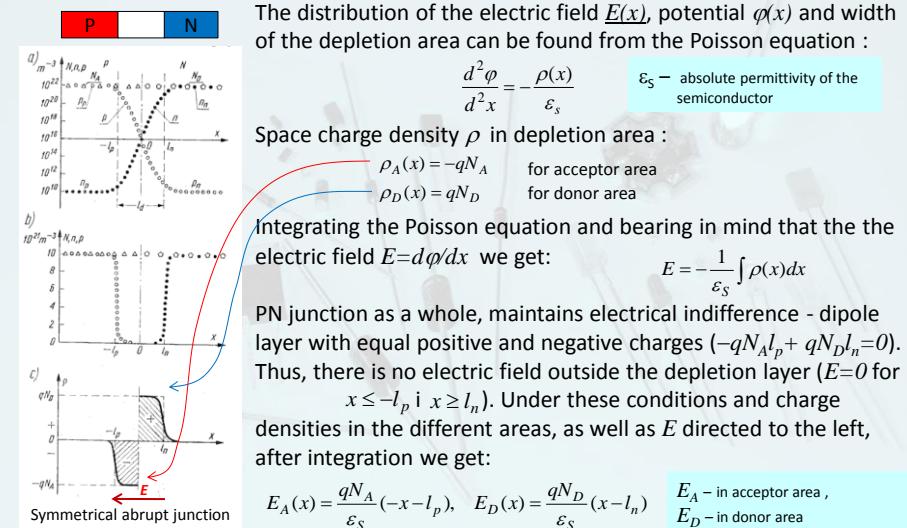
Figures from: W. Marciniak, „Przyrządy półprzewodnikowe i układy scalone”, WNT 1979

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DEPLETION AREA ANALYSIS



The distribution of the electric field $E(x)$, potential $\phi(x)$ and width of the depletion area can be found from the Poisson equation :

$$\frac{d^2\phi}{dx^2} = -\frac{\rho(x)}{\epsilon_s}$$

ϵ_s – absolute permittivity of the semiconductor

Space charge density ρ in depletion area :

$$\rho_A(x) = -qN_A \quad \text{for acceptor area}$$

$$\rho_D(x) = qN_D \quad \text{for donor area}$$

Integrating the Poisson equation and bearing in mind that the electric field $E = d\phi/dx$ we get:

$$E = -\frac{1}{\epsilon_s} \int \rho(x) dx$$

PN junction as a whole, maintains electrical indifference - dipole layer with equal positive and negative charges ($-qN_A l_p + qN_D l_n = 0$). Thus, there is no electric field outside the depletion layer ($E=0$ for $x \leq -l_p$ i $x \geq l_n$). Under these conditions and charge densities in the different areas, as well as E directed to the left, after integration we get:

$$E_A(x) = \frac{qN_A}{\epsilon_s} (-x - l_p), \quad E_D(x) = \frac{qN_D}{\epsilon_s} (x - l_n)$$

E_A – in acceptor area ,
 E_D – in donor area

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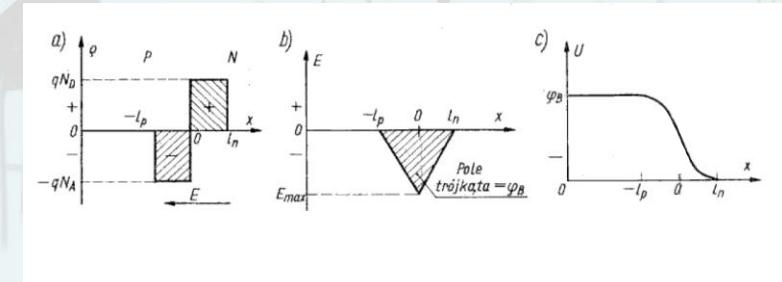
DEPLETION AREA ANALYSIS

The electric field preserves continuity at the transition between acceptor and donor areas : $E_A(0)=E_D(0)$. Furthermore, at this point its maximum is:

$$E_{\max} = \frac{-qN_A l_p}{\epsilon_s} = \frac{qN_D l_n}{\epsilon_s}$$

Potential distribution $\varphi(x)$ can be calculated by integrating the electric field $E(x)$ within $-l_p$ to l_n (figure below). In contrast, the potential difference is the potential barrier φ_B (diffusion voltage):

$$\varphi_B = \frac{1}{2} E_{\max} l_d \quad l_d = l_p + l_n \quad l_d - \text{width of the depletion area}$$



Rysunki zaczerpnięte z W. Marciniak „Przyrządy półprzewodnikowe i układy scalone”, WNT 1979



DEPLETION AREA ANALYSIS

Using the above equations and the "leverage law" ($N_A l_p = N_D l_n$), width of the depletion layer l_d , can be shown as:

$$l_d = \frac{2\varphi_B}{E_{\max}} = \sqrt{\frac{2\epsilon_s(N_D + N_A)\varphi_B}{qN_D N_A}}$$

Using the fact that in a state of thermodynamic equilibrium, drift current is equal to the diffusion current ($J_u = J_d$), one can determine the value of the potential barrier.

For example, for holes:

$$qD_p \frac{dp}{dx} = q\mu_p pE$$

using Einstein's equations ($kT/q = D/\mu$) and ($\varphi_T = kT/q$) we can write:

$$\varphi_T \frac{dp}{p} = Edx$$

Integrating the concentration of holes and length of depletion layer :

we get: $\varphi_B = \varphi_T \ln(p_p / p_n)$

$$\varphi_T \int_{p_p}^{p_n} \frac{dp}{p} = \int_{-l_p}^{l_n} Edx = -\varphi_B$$

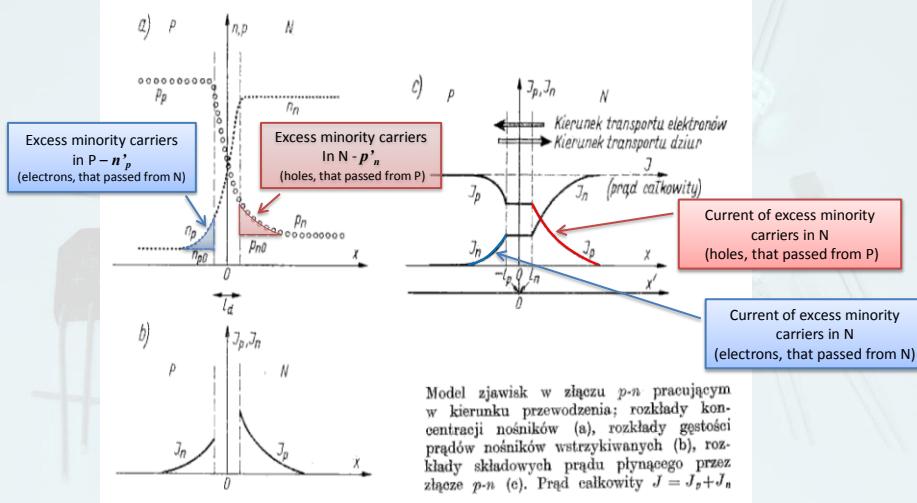
or for electrons: $\varphi_B = \varphi_T \ln(n_n / n_p)$

Taking into account: $n_n \approx N_D$ i $p_p \approx N_A$ and $np = n_i^2$ we get:

$$\boxed{\varphi_B = \varphi_T \ln(N_D N_A / n_i^2)}$$



I vs. U CHARACTERISTIC



Figures from: W. Marciński „Przyrządy półprzewodnikowe i układy scalone”, WNT 1979

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I vs. U CHARACTERISTIC

Total current (for simplicity we omitted depleted layer – x' axis):

$$J = J_{dn|x'=0} + J_{dp|x'=0}$$

only diffusion components:

$$J_{dn} = qD_n \frac{dn_p}{dx'} \Big|_{x'=0} \quad \text{for electrons}$$

$$J_{dp} = -qD_p \frac{dp_n}{dx'} \Big|_{x'=0} \quad \text{for holes}$$

The concentration of the injected carriers through the depletion area :

$$n_p = n_{p0} + n'_p(0) \exp(-x/L_n), \quad p_n = p_{n0} + p'_n(0) \exp(-x/L_p)$$

n_{p0}, p_{n0} – concentration of minority carriers in thermodynamic equilibrium ,

$n'_p(0), p'_n(0)$ – Concentrations of excess minority carriers for $x=0$

finally:

$$J = q \left[\frac{D_n n_{p0}}{L_n} + \frac{D_p n_{n0}}{L_p} \right] \left(e^{\frac{U}{\varphi_T}} - 1 \right)$$

„diffusion diode”

J_s – saturation current density

$$I_D = I_S \left(e^{\frac{U}{\varphi_T}} - 1 \right) \quad I_S = qA \left[\frac{D_n n_{p0}}{L_n} + \frac{D_p n_{n0}}{L_p} \right]$$

current $I_S = J_s A$, where: A this junction cross-sectional area

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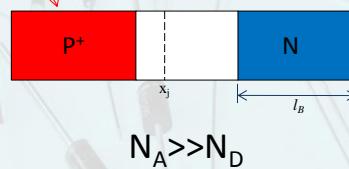


BASE AND Emitter OF PN JUNCTION



In the case of asymmetrical junctions :

- ***junction base*** – less doped area
- ***junction emitter*** – heavily doped layer



junction with very narrow base: $l_B < L_n$